(Day/Month/Year Filed)

Declaration For U.S. Patent Application

#3

☐ Yes ☐ No

As a below named inventor, I hereby declare that: FEB 0 8 2002

My residence, post office address and citizenship are as stated below next to my name.

(Number)

I believe I am the original, first and sole inventor (if only one name is listed below) or an original, first and joint inventor (if plural names are listed below) of the subject matter which is claimed and for which a patent is sought on the invention entitled (Insert Title) NEGATIVE PHOTOSENSITIVE RESIN COMPOSITION, NEGATIVE PHOTOSENSITIVE DRY FILM

AND METHOD OF FORMING PATTERN
the specification of which is attached hereto unless the following is checked:

no specimento.	or whom to atmond horder amond the for	to wing is encoured.		
	was filed on October 15, 200	1as Unite	ed States Application Number or	PCT International
x	Application Number 09/976279		and was amended on	
<u> </u>	(if applicable).			
-	nat I have reviewed and understand the content referred to above.	tents of the above-identified	specification, including the claim	m(s), as amended
acknowledge t	he duty to disclose information which is ma	terial to patentability as defi	ned in Title 37, Code of Federal R	tegulations, § 1.56.
nventor's certif	foreign priority benefits under Title 35, Unficate listed below and have also identified that of the application on which priority is	below any foreign applicati		
Eist prior	2000-315647	Japan	16/10/2000	Priority Claimed
foreign	(Number)	(Country)	(Day/Month/Year Filed)	- <i>n</i>
applications.	(Number)	(Country)	(Day/Month/Year Filed)	_
See note A on back of		· · · · · · · · · · · · · · · · · · ·		_ • Yes • No
this page)	(Number)	(Country)	(Day/Month/Year Filed)	

(See note B on back of this page)

☐ See attached list for additional prior foreign applications

(Country)

I hereby claim the benefit under Title 35, United States Code, § 119(e) of any United States provisional application(s) listed below.

(Application Number)	(Filing Date)
(Application Number)	(Filing Date)

I hereby claim the benefit under Title 35, United States Code, § 120 of any United States application(s) listed below and, insofar as the subject matter of each of the claims of this application is not disclosed in the prior United States application in the manner provided by the first paragraph of Title 35, United States Code, § 112, I acknowledge the duty to disclose information which is material to patentability as defined in Title 37, Code of Federal Regulations, § 1.56 which became available between the filing date of the prior application and the national or PCT international filing date of the application:

(List Prior U.S. Applications)	(Application Serial Number)	(Filing Date)	(Status) (patented, pending, abandoned)
	(Application Serial Number)	(Filing Date)	(Status) (patented, pending, abandoned)

I hereby appoint the following attorney(s) and/or agent(s) to prosecute this application and to transact all business in the Patent and Trademark Office connected therewith:

James E. Armstrong, III, Reg. No. 18,366; William F. Westerman, Reg. No. 29,988; Ken-Ichi Hattori, Reg. No. 32,861; Le-Nhung McLeland, Reg. No. 31,541; Ronald F. Naughton, Reg. No. 24,616; John R. Pegan, Reg. No. 18,069; William G. Kratz, Jr., Reg. No. 22,631; Albert Tockman, Reg. No. 19,722; Mel R. Quintos, Reg. No. 31,898; Donald W. Hanson, Reg. No. 27,133; Stephen G. Adrian, Reg. No. 32,878; William L. Brooks, Reg. No. 34,129; John F. Carney, Reg. No. 20,276; Edward F. Welsh, Reg. No. 22,455; Patrick D. Muir, Reg. No. 37,403; Gay A. Spahn, Reg. No. 34,978; and John P. Kong, Reg. No. 40,054.

Please direct all communications to the following address:

ARMSTRONG, WESTERMAN, HATTORI, McLELAND & NAUGHTON 1725 K Street, N.W., Suite 10

Washington, D.C. 20006

Telephone: (202) 659-2930 Fax: (202) 887-0357

I hereby declare that all statements made herein of my own knowledge are true and that all statements made on information and belief are believed to be true; and further that these statements were made with the knowledge that willful false statements and the like so made are punishable by fine or imprisonment, or both, under Title 18 of the United States Code, § 1001 and that such willful false statements may jeopardize the validity of the application or any patent issued thereon.

	Full name of sole or first inventor (given name, family name)	1 IMAI		
(See note C above)	Inventor's Signature South	Date	January 23,	2002
C above)	Residence Hiratsuka-shi, Kanagawa-ken, Japan Ci	itizenship	Japan	
	Post Office Address <u>4-13-12</u> , <u>Higashiyawata</u> , <u>Hiratsuka</u>	ahi Kan		Taman .
	Fost Office Address 4-13-12, Higasittyawata, Hitatsuka	-SIII, Nai	iagawa-keii,	Japan
Full name of sec	ond inventor (given name, family name)			
Inventor's Signat	ture	Date		
Residence	Ci	itizenship		
Post Office Addr	ress			
Fill name of this	rd inventor (given nome family nome)			
154	rd inventor (given name, family name)tureture			
7:	Ci			
## 13	ressCi			
· 44:				
Full name of four	rth inventor (given name, family name)			
	ture			
Residence	Ci	itizenship		
Post Office Addr	ress			
Full name of fifth	h inventor (given name, family name)			
# (E)	ture			
Residence	Ci	itizenship	·	
Post Office Addr	ess			
	th inventor (given name, family name)			
	ture			
	Ci			
	ess			
Full name of seve	enth inventor (given name, family name)		,	
	ture			
Residence	Ci			
Post Office Addre	ess			
Full name of eigh	hth inventor (given name, family name)			
Inventor's Signat	ture	Date		
Residence		itizenship		
	ess	г		